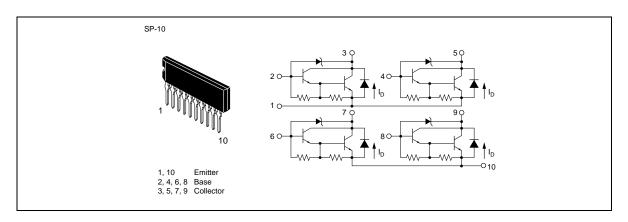
Silicon NPN Epitaxial

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Application

Low frequency power amplifier

Outline



Absolute Maximum Ratings (for each device, $Ta = 25^{\circ}C$)

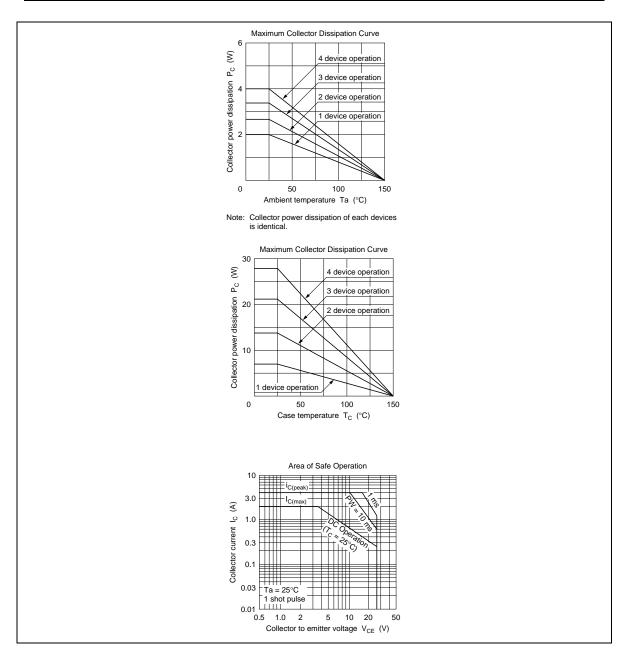
Item	Symbol	Ratings	Unit
Collector to base voltage	V _{cbo}	27	V
Collector to emitter voltage	V _{ceo}	27	V
Emitter to base voltage	V _{ebo}	7	V
Collector current	I _c	2	А
Collector peak current	I _{C(peak)}	4	А
Diode current	I _D	2	А
Collector power dissipation	P _c * ¹	4	W
	P_{c}^{*1} (T _c = 25°C)	28	
Junction temperature	Tj	150	°C
Storage temperature	Tstg	–55 to +150	°C

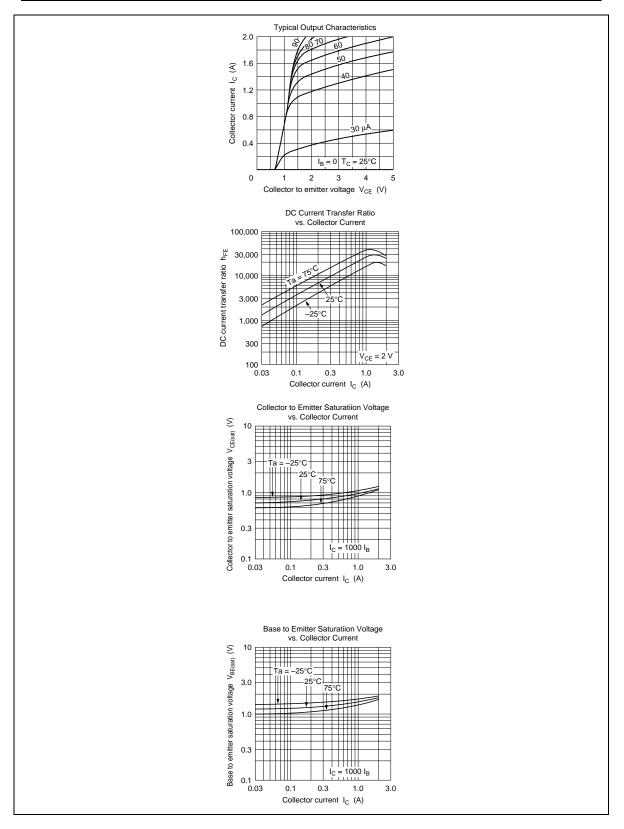
Note: 1. 4 devices operation.

Electrical Characteristics (for each device, $Ta = 25^{\circ}C$)

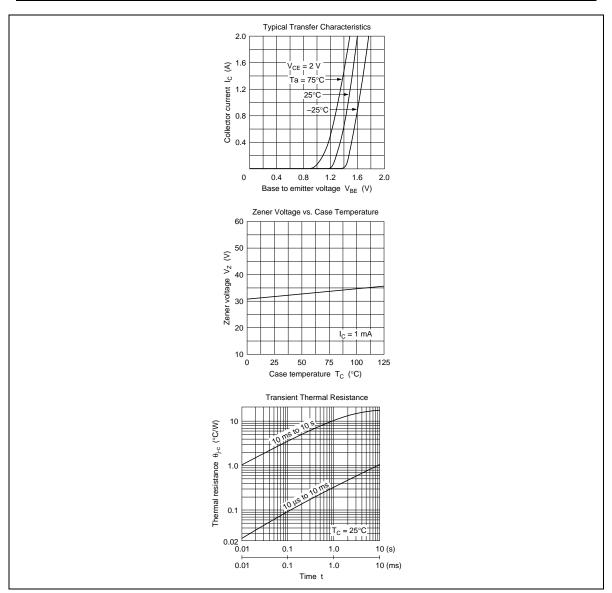
Item	Symbol	Min	Тур	Мах	Unit	Test conditions
Collector to emitter breakdown voltage	$V_{\scriptscriptstyle (BR)CBO}$	27		_	V	$I_{c} = 1 \text{ mA}, I_{e} = 0$
Collector to emitter sustain voltage	$V_{\text{CEO(SUS)}}$	28		36	V	I_{c} = 1 A, L = 20 mH, R_{BE} = ∞
Emitter to base breakdown voltage	$V_{\scriptscriptstyle (BR)EBO}$	7	_	—	V	$I_{\rm e} = 5$ mA, $I_{\rm c} = 0$
Collector cutoff current	I _{cbo}	—	—	10	μA	$V_{_{CB}} = 20 \text{ V}, \text{ I}_{_{E}} = 0$
	I _{ceo}	—	—	10	_	V_{ce} = 20 V, R_{be} = ∞
DC current transfer ratio	h _{FE}	7000	_	30000		$V_{ce} = 2 V, I_c = 0.5 A$
	h _{FE}	2000	_	_		$V_{ce} = 2 V, I_c = 2 A^{*1}$
Collector to emitter saturation voltage	$V_{\scriptscriptstyle CE(sat)}$	_	_	1.5	V	$I_{c} = 2 \text{ A}, I_{B} = 2 \text{ mA}^{*1}$
Base to emitter saturation voltage	$V_{\text{BE(sat)}}$	_	_	2.0	V	$I_{c} = 2 \text{ A}, I_{B} = 2 \text{ mA}^{*1}$
C to E diode forward current	V _D	_	_	3.5	V	$I_{D} = 2 A$
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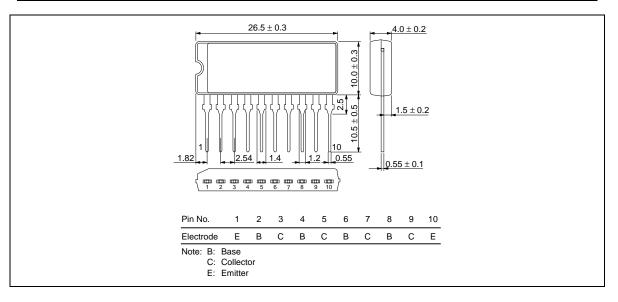
Note: 1. Pulse test.





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